

LM123, LM323-N, LM323A

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LM123/LM323A/LM323-N 3-Amp, 5-Volt Positive Regulator

Check for Samples: LM123, LM323-N, LM323A

FEATURES

- Ensured 1% Initial Accuracy (A Version)
- 3 Amp Output Current
- Internal Current and Thermal Limiting
- 0.01Ω Typical Output Impedance
- 7.5V Minimum Input Voltage
- 30W Power Dissipation
- P⁺ Product Enhancement tested

DESCRIPTION

The LM123 is a three-terminal positive regulator with a preset 5V output and a load driving capability of 3 amps. New circuit design and processing techniques are used to provide the high output current without sacrificing the regulation characteristics of lower current devices.

The LM323A offers improved precision over the standard LM323-N. Parameters with tightened specifications include output voltage tolerance, line regulation, and load regulation.

The 3 amp regulator is virtually blowout proof. Current limiting, power limiting, and thermal shutdown provide the same high level of reliability obtained with these techniques in the LM109 1 amp regulator.

No external components are required for operation of the LM123. If the device is more than 4 inches from the filter capacitor, however, a 1 μ F solid tantalum capacitor should be used on the input. A 0.1 μ F or larger capacitor may be used on the output to reduce load transient spikes created by fast switching digital logic, or to swamp out stray load capacitance.

An overall worst case specification for the combined effects of input voltage, load currents, ambient temperature, and power dissipation ensure that the LM123 will perform satisfactorily as a system element.

For applications requiring other voltages, see LM150 series adjustable regulator data sheet.

Operation is specified over the junction temperature range -55°C to +150°C for LM123, -40°C to +125°C for LM323A, and 0°C to +125°C for LM323-N. A hermetic TO-3 package is used for high reliability and low thermal resistance.

Connection Diagram



Figure 1. See Package Number NDS

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Typical Applications



*Required if LM123 is more than 4" from filter capacitor. †Regulator is stable with no load capacitor into resistive loads.

Figure 2. Basic 3 Amp Regulator



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾ (2)(3)

Input Voltage	20V	
Power Dissipation	Internally Limited	
Operating Junction Temperature Range	LM123	−55°C to +150°C
	LM323A	−40°C to +125°C
	LM323-N	0°C to +125°C
Storage Temperature Range	−65°C to +150°C	
Lead Temperature (Soldering, 10 sec.)	300°C	
ESD Tolerance ⁽⁴⁾	2000V	

 "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.

(2) Refer to RETS123K drawing for LM123K military specifications.

(3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

(4) Human body model, 1.5 k Ω in series with 100 pF.

LM123 Electrical Characteristics⁽¹⁾

Parameter	(Conditions		Units			
			Min	Тур	Max		
Output Voltage	T _j = 25°C V _{IN} = 7.5V, I _O	_{UT} = 0A	4.7	5	5.3	V	
	$7.5V \le V_{IN} \le 1$ $0A \le I_{OUT} \le 3/$	I5V A, P ≤ 30W	4.6		5.4	V	
Line Regulation ⁽²⁾	$T_j = 25^{\circ}C$ 7.5V $\leq V_{IN} \leq 15V$			5	25	mV	
Load Regulation ⁽²⁾	$T_j = 25^{\circ}C, V_{IN}$ $0A \le I_{OUT} \le 3/2$	= 7.5V, A		25	100	mV	
Quiescent Current	$7.5V \le V_{IN} \le 1$ $0A \le I_{OUT} \le 3/$	$7.5V \le V_{IN} \le 15V,$ $0A \le I_{OUT} \le 3A$		12	20	mA	
Output Noise Voltage	T _j = 25°C 10 Hz ≤ f ≤ 10	00 kHz		40		µVrms	
Short Circuit Current Limit	T _j = 25°C	V _{IN} = 15V		3	4.5	А	
		V _{IN} = 7.5V		4	5	А	
Long Term Stability					35	mV	
Thermal Resistance Junction to Case ⁽³⁾				2		°C/W	

(1) Unless otherwise noted, specifications apply for $-55^{\circ}C \le T_j \le +150^{\circ}C$ for the LM123, $-40^{\circ}C \le T_j \le +125^{\circ}C$ for the LM323A, and $0^{\circ}C \le T_j \le +125^{\circ}C$ for the LM323-N. Although power dissipation is internally limited, specifications apply only for P \le 30W.

(2) Load and line regulation are specified at constant junction temperature. Pulse testing is required with a pulse width ≤ 1 ms and a duty cycle ≤ 5%.

(3) Without a heat sink, the thermal resistance of the TO-3 package is about 35°C/W. With a heat sink, the effective thermal resistance can only approach the specified values of 2°C/W, depending on the efficiency of the heat sink.

LM323A/LM323-N Electrical Characteristics ⁽¹⁾

Parameter	Conditions		LM323A			LM323-N			Units
			Min	Тур	Max	Min	Тур	Мах	
Output Voltage	$\begin{array}{l} T_{j=25^{\circ}C}\\ V_{IN=7.5V, I_{C}} \end{array}$	$\begin{array}{l} T_{j} = 25^\circC \\ V_{IN} = 7.5V, \ I_{OUT} = 0A \end{array}$			5.05	4.8	5	5.2	V
	$7.5V \le V_{IN} \le$ $0A \le I_{OUT} \le 3$	4.85		5.15	4.75		5.25	V	
Line Regulation ⁽²⁾	$\begin{array}{l} T_{j=25^{\circ}C}\\ 7.5V\leqV_{IN}\leq \end{array}$		5	10		5	25	mV	
Load Regulation ⁽²⁾	$T_j = 25^{\circ}C, V_{II}$ $0A \le I_{OUT} \le 3$		25	50		25	100	mV	
Quiescent Current	$7.5V \le V_{IN} \le 15V$, $0A \le I_{OUT} \le 3A$			12	20		12	20	mA
Output Noise Voltage	T _j = 25°C 10 Hz ≤ f ≤ 100 kHz			40			40		µVrms
Short Circuit Current Limit	T _j = 25°C	V _{IN} = 15V		3	4.5		3	4.5	А
		V _{IN} = 7.5V		4	6		4	5	А
Long Term Stability					35			35	mV
Thermal Resistance Junction to Case $^{(3)}$				2			2		°C/W

Unless otherwise noted, specifications apply for -55°C ≤ T_j ≤ +150°C for the LM123, -40°C ≤ T_j ≤ +125°C for the LM323A, and 0°C ≤ T_j ≤ +125°C for the LM323-N. Although power dissipation is internally limited, specifications apply only for P ≤ 30W.
Load and line regulation are specified at constant junction temperature. Pulse testing is required with a pulse width ≤ 1 ms and a duty

cycle $\leq 5\%$.

(3) Without a heat sink, the thermal resistance of the TO-3 package is about 35°C/W. With a heat sink, the effective thermal resistance can only approach the specified values of 2°C/W, depending on the efficiency of the heat sink.

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125

100

= 25°C

15

ĴμF

100K 1M

20

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*Select for 20 mA Current from Unregulated Negative Supply

Figure 15. 10 Amp Regulator with Complete Overload Protection

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*R6 =
$$\frac{V^-}{12 \text{ mA}}$$

 $A_1 \mbox{--} LM101A$ $C_1 \mbox{---} 2 \mbox{ } \mu F$ Optional $\mbox{---} Improves$ Ripple Rejection, Noise, and Transient Response









*Select to Set Output Voltage **Select to Draw 25 mA from V⁻

Figure 18. Adjustable Output 5V-10V 0.1% Regulation

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Schematic Diagram





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM323K STEEL	ACTIVE	TO-3	NDS	2	50	Non-RoHS & Non-Green	Call TI	Call TI	0 to 125	LM323K STEEL	Samples
LM323K STEEL/NOPB	ACTIVE	TO-3	NDS	2	50	RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 125	LM323K STEEL	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

w

(mm)

215.9

215.9

292.1

K0

(µm)

25654

25654

P1

(mm)

3.87

3.87

CL

(mm)

22.3

22.3

CW

(mm)

25.4

25.4

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TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

NDS

LM323K STEEL/NOPB

All dimensions are nominal											
Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)				
LM323K STEEL	NDS	TO-CAN	2	50	9 X 6	NA	292.1				

2

50

9 X 6

NA

TO-CAN

Pack Materials-Page 1

NDS0002A



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